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Hirokazu HONDA

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2. Name and address of receiving party(ies):

Name: NEC Electronics Corporation

Address: 1753 Shimonumabe

Nakahara-ku, Kawasaki

City: Kanagawa

State/Prov.:

Country: JAPAN

ZIP: 211-8668

Additional name(s) & address(es)

☐ Yes ☒ No

Additional names(s) of conveying party(ies)

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Execution Date: January 21, 2004

4. Application number(s) or patent numbers(s):

10763554

If this document is being filed together with a new application, the execution date of the application is: January 21, 2004

Patent Application No.

Filing date

B. Patent No.(s)

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Norman P. Soloway

Registration No. 24,315

Address: HAYES SOLOWAY P.C.

130 W. Cushing Street

City: Tucson

State/Prov.: Arizona

Country: U.S.A.

ZIP: 85701

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

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ASSIGNMENT

FOREIGN - IN THE UNITED STATES OF AMERICA

I/we, HIROKAZU HONDA

of Kanagawa, Japan

having invented certain inventions and improvements in

WARP-SUPPRESSED SEMICONDUCTOR DEVICE

and having executed an application for Letters Patent of the United States of America describing the same and based thereon on

January 21, 2004, for good and valuable consideration, the receipt of which is hereby acknowledged, from

NEC Electronics Corporation a Japanese corporation having its principal place of business at 1753 Shimonumabe, Nakahara-ku, Kawasaki, Kanagawa 211-8668, Japan (hereinafter

called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns our entire rights, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications, and any patent which may be issued on the said invention in the United States of America.

And for the same consideration, I/we do hereby agree that I/we will upon request execute any instrument which the Assignee may desire to carry this Assignment into effect and perfect the title transferred hereby or prosecute the above-mentioned application.

And I/we do hereby authorize the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent on the said application to the Assignee.

And I/we do hereby jointly and severally covenant for ourselves and for our legal representatives that I/we have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our rights, title, and interest in and to said inventions or any of them or any part thereof has not been otherwise encumbered by us, and that I/we have not executed and will not execute any instrument in conflict herewith.

IN WITNESS WHEREOF, I/we have hereunto set our hands and seals on the day and year hereinafter noted.

Sole or First

Inventor's signature Hirokazu Honda  Date January 21, 2004
Full name (typed or printed) HIROKAZU HONDA

Witness: Tetsushi Oikawa Witness: Tetsushi Oikawa
Date: January 21, 2004 Date: January 21, 2004

Second Inventor's
signature _____ Date _____
Full name (typed or printed) _____

Witness: _____ Witness: _____
Date: _____ Date: _____

Third Inventor's
signature _____ Date _____
Full name (typed or printed) _____

Witness: _____ Witness: _____
Date: _____ Date: _____